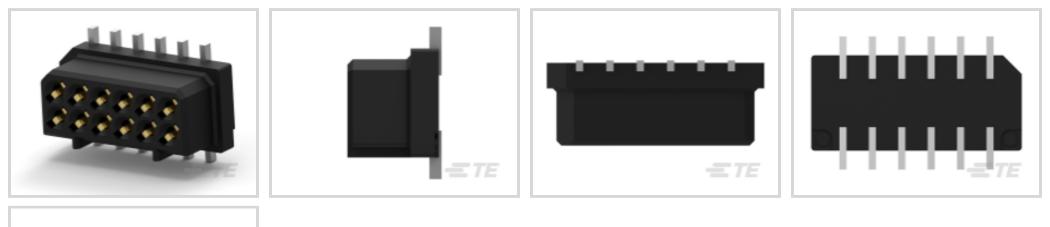
4-175630-2 - ACTIVE

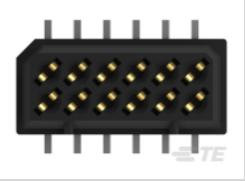
TE Internal #: 4-175630-2 PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 1.25 mm [.049in] Centerline, Tin, Printed Circuit Board, .5A Contact Current Rating (Max)

View on TE.com >



Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles





PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 12

Centerline (Pitch): 1.25 mm [.049 in]

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle	
Connector System	Board-to-Board	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Rows	2	
Stackable	Yes	
PCB Mount Orientation	Vertical	
Number of Positions	12	
Board-to-Board Configuration	Parallel	
Electrical Characteristics		
Dielectric Withstanding Voltage (Max)	500 VAC	
Insulation Resistance	2 ΜΩ	
Operating Voltage	50 VAC	

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 1.25mm [.049in] Centerline, Tin, Printed Circuit Board, .5A Contact Current Rating (Max)



Contact Features

Contact Layout	Inline
PCB Contact Termination Area Plating Material Thickness	.8 μm[31.5 μin]
Mating Pin Diameter	.5 mm[.02 in]
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.8 μm[31.5 μin]
Contact Type	Socket
Contact Current Rating (Max)	.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.3 mm[.012 in]
Rectangular Termination Post & Tail Width	1.8 mm[.07 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Alignment Type	None
PCB Mount Retention Type	None
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	1.25 mm[.049 in]
Housing Color	Black
Housing Material	Polyphenylene Sulfide (PPS)
Dimensions	
Stack Height	5 mm, 6.5 mm, 7 mm, 10.5 mm[.197 in][.256 in][.276 in][.413 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 1.25mm [.049in] Centerline, Tin, Printed Circuit Board, .5A Contact Current Rating (Max)



Operation/Application

Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	1500
Packaging Method	Tape & Reel
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211)

Halogen Content

BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.

Solder Process Capability

Reflow solder capable to 245°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

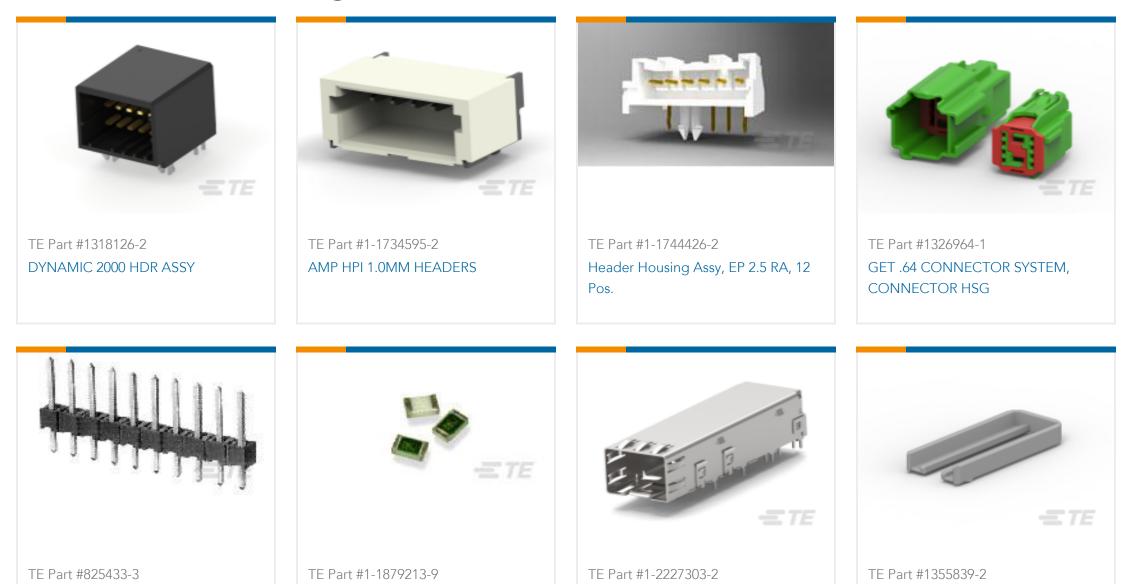
Compatible Parts

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 1.25mm [.049in] Centerline, Tin, Printed Circuit Board, .5A Contact Current Rating (Max)



TE Part # 9-176891-2	TE Part # 9-176890-2	TE Part # 4-720998-4	TE Part # 720999-8
1.25FP,P12,DL,O,C,TR,5.00,6.90	1.25FP,P12,DL,WB,TR,MYLAR	COVER TAPE 13.5W	EMBOSS TAPE

Customers Also Bought



MOD 2 PINHDR 1X3 P.	CPF 0402 40R2 0.1% 25PPM 1K RL	CAGE ASSEMBLY, SFP, .071 TAIL	2.KONTAKTSICHERUNG
= TE			
TE Part #1-2176263-6			

Documents

Product Drawings 1.25FP,R12,DL,O,N,TR

RN 0402 34K8 0.1% 10PPM 5K RL

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_4-175630-2_D.2d_dxf.zip

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 1.25mm [.049in] Centerline, Tin, Printed Circuit Board, .5A Contact Current Rating (Max)



English

Customer View Model ENG_CVM_CVM_4-175630-2_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_4-175630-2_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications AMP 1.25mm F-P Connector (Board To Board)

Japanese

Product Specification

Japanese